

EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated 12500 TI Boulevard Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

| Marketing Name: | ▼ | |
|------------------------|---------------------------------|--|
| | Wireless Microcontroller Module | |
| Equipment Name: | 2.4GHz Wi-Fi® Module | |
| Model Number: | CC3220MODASF12MON | |
| SW Version: | 2.2.0.xx | |

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

Radio Equipment Directive 2014/53/EU RoHS2 Directive 2011/65/EU

Accessories information:

Antennas

| | | List | | |
|----|---|---------------------------------|---------------------|-------------|
| | Brand | Antenna Type | Model | 2.4GHz gain |
| 1 | FoxCon | PCB | T77H533 | 2.5dBi |
| 2 | Ethertronics | Dipole | 1000423 | -0.6dBi |
| 3 | | Rubber Whip / Dipole | 001-0012 | 2dBi |
| 4 | | | 080-0013 | 2dBi |
| 5 | LSR | | 080-0014 | 2dBi |
| 6 | | PIFA | 001-0016 | 2.5dBi |
| 7 | ======================================= | PIFA | 001-0021 | 2.5dBi |
| 8 | Laird | DOD | CAF94504 | 2dBi |
| 9 | Lairo | PCB | CAF9405 | 2dBi |
| 10 | ACX | Multilava Chia | AT3216-BR2R7HAA | 0.5dBi |
| 11 | AUA | Multilayer Chip | AT312-T2R4PAA | 1.5dBi |
| 12 | TDK | Multilayer Ceramic Chip Antenna | ANT016008LCD2442MA1 | 1.6dBi |
| 13 | TUK | Withhayer Ceramic Chip Antenna | ANT016008LCD2442MA2 | 2.5dBi |
| 14 | Mitsubishi Material | Chip Antenna | AM03DP-ST01 | 1.6dBi |
| 15 | Wittsubistii Wateriai | Antenna Unit | UB18CP-100ST01 | -1.0dBi |
| 16 | | Chip Antenna / Herical Monopole | AF216M245001 | 1.5dBi |
| 17 | Taiyo Yuden | Chin Antonio Manager Trans | AH212M245001 | 1.3dBi |
| 18 | | Chip Antenna /Monopole Type | AH316M245001 | 1.9dBi |
| 19 | | | AA2402SPU | 2.0dBi |
| 20 | Antenna Technology | Dipole | AA2402RSPU | 2.0dBi |
| 21 | | | AA2402A-UFLLP | 2.0dBi |
| | | | | |



| 22 | | | AA2402AU-UFLLP | 2.0dBi |
|----|-----------------------|----------------------------|---------------------|---------|
| 23 | Staf | -302772 | 1019-016 | 2.14dBi |
| 24 | | Staf Mono-pole | 1019-017 | 2.14dBi |
| 25 | | | 1019-018 | 2.14dBi |
| 26 | | | 1019-019 | 2.14dBi |
| 27 | | - | MEIWX-2411SAXX-2400 | 2.0dBi |
| 28 | Map Electronics | ap Electronics Rubber Whip | MEIWX-2411RSXX-2400 | 2.0dBi |
| 29 | | | MEIWX-282XSAXX-2400 | 2.0dBi |
| 30 | | | MEIWX-282XRSXX-2400 | 2.0dBi |
| 31 | | | MEIWF-HP01RS2X-2400 | 2.0dBi |
| 32 | Yageo | Chip | ANT3216A063R2400A | 1.69dBi |
| 33 | Man Lauren Cainstiffe | Chin | LTA-3216-2G4S3-A1 | 1dBi |
| 34 | Mag Layers Scientific | Chip | LTA-3216-2G4S3-A3 | 2dBi |
| 35 | Advantech | Rubber Whip / Dipole | AN2450-5706RS | 2.38dBi |

The following harmonized standards and technical specifications have been applied:

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|--|---|
| EN 301489-1 V2.1.1 (2017-02) | ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements; Harmonised Standard covering the essential requirements of article 3.1(b) of Directive 2014/53/EU and the essential requirements of article 6 of Directive 2014/30/EU |
| EN 301489-1 V2.2.3 (2019-11) | ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements; Harmonised Standard for ElectroMagnetic Compatibility |
| EN 301489-17 V3.1.1 (2017-02) | ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 17: Specific conditions for Broadband Data Transmission Systems; Harmonised Standard covering the essential requirements of article 3.1(b) of Directive 2014/53/EU |
| EN 300328 v2.2.2 (2019-07) | Wideband transmission systems; Data transmission equipment operating in the 2,4 GHz band; Harmonised Standard for access to radio spectrum |
| EN 62311:2008 | Assessment of electronic and electrical equipment related to human exposure restrictions for electromagnetic fields (0 Hz - 300 GHz) |
| EN 62368-1:2014+A11:2017 | Audio/video, information and communication technology equipment Part 1: Safety requirements |
| EN 50581:2012 | Technical documentation for the assessment of electrical and electronic products with respect to the restrictions of hazardous substances |



Notified Body:

| Notified Body: | PHOENIX TESTLAB GMBH |
|--|----------------------|
| Notified Body Number | 700 |
| Reference number of the certificate of notified body | 20-211369 |

Technical Compliance File Held by:

Texas Instruments Incorporated 12500 TI Boulevard Dallas, Texas 75243 USA

Signed for and on behalf of Texas Instruments Incorporated

| Name: | Mattias Lange, General Manager |
|----------|--|
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Dallas TX 1/7/2021

Place of issue Date of issue

Signature of Authorized Person

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